

REI-2017 will be the 19th international conference dedicated to research relating to radiation effects in insulators and non-metallic materials. In 2017, discover REI in Versailles, a city which was shaped by French History and in particular under the period of King Louis XIV, at only 20 km from Paris.

Since its first edition in 1981 in Arco, Italy, REI has been the international forum held every two years to present and discuss the latest achievements in the field of insulating materials modification through different kinds of radiation sources (ions, electrons, neutrons...). The REI conference is one of the most prominent and long running conference series in the field of radiation effects in materials.

http://rei2017.sciencesconf.org

TOPICS

- Radiation Effects in Insulators : oxides, carbides, glasses, polymers, composites
- Fundamental knowledge on atomistic and electronic defect production and stability
- Irradiation-induced microstructural evolution and material modifications
- Fundamentals, theory and computer simulations
- Advances in defect and material characterization
- Swift heavy ion irradiations
- lon, electron and neutron irradiations
- Laser-solid interactions
- Multi-ion beam irradiations
- Nuclear materials: fission, fusion and waste forms
- Micro- and nano-patterning
- Materials processing with swift heavy ions and cluster beams

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SAVE THE DATE!

Sept 2016 : Call for abstracts Jan 2017 : Abstract submission deadline Feb 2017: Notification of abstract acceptance Mar. 2017: Online registration starts June 30 – July 1, 2017: International School Jul 2, 2017 : Conference starts (welcome reception) Jul 3, 2017: Manuscript submission deadline Jul 7, 2017: Conference ends Nov 2017 : Full proceedings submitted to Elsevier



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CSNS







We invite **sponsors to support the REI-19 international conference** which will be held in **Versailles, France, in July 2017**.

It is organized by laboratories all members of the new Université Paris-Saclay : (i) the CSNSM, a joint research unit of Université Paris-Sud and CNRS, (ii) the SRMP (DEN/DMN) at CEA Saclay (iii) the LSI lab (CEA-CNRS-Polytechnic School)

Sponsorship is an important aspect to make the conference a success and will help to provide an environment that will facilitate stimulating discussions.

About 200 participants from all over the world are expected.

We propose sponsorship as detailed below:

Basic sponsorship level : 2000 €

- Your logo on the abstract book and the conference web site (first page + sponsors page, with a brief description text) + a link to your website
- Possibility to add goodie(s) and leaflet(s) in the welcome package given to all the participants
- Registration to the whole conference, including social events, for one person

Options to brand parts of the conference: contact us for the price

Your logo on the delegate bag (one colour printing within logo)2 spaces availableYour logo on posters at coffee break1 space per break availableYour logo on posters at one of the lunches1 space per lunch availableYour logo at the banquet3 spaces availableYour logo at the welcome reception3 spaces availableYour logo on the lanyards worn during the whole conference2 spaces availableOther options, please ask us3

Please do not hesitate to contact us for any question at

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We are looking forward to receiving your support !